### Preliminary

TOSHIBA LED Lamp

# TLRE1005B (T03), TLSE1005B (T03), TLOE1005B (T03), TLYE1005B (T03), TLGE1005B (T03), TLGE1005B (T03), TLPGE1005B (T03)

panel Circuit Indicator

- 3.2 (L)  $\times$  2.4 (W)  $\times$  2.4 (H) mm TL $\Box$ E1005B (T03) Series
- $\phi$ 2 mm lens top type
- InGaA $\ell$ P LED
- It can be manufactured high-luminosity of equipment or reduce of electric power consumption by change in the high-luminosity LED from general-luminosity one.
- Colors: Red, Orange, Yellow, Green, Pure green
- Can be mounted using surface mounter.
- Reflow soldering is possible.
- Standard embossed taping 4 mm pitch: T03 (1000 pcs/reel)
- Applications: High-output backlighting source, battery-powered equipment, message boards and portable devices

#### Unit in mm POLARITY $\frac{1}{2}$ CATHODE INDEX $(5^{\circ})$ (22)(2

### Line-up

Product name	Color	Material
TLRE1005B	Red	
TLSE1005B	Red	
TLOE1005B	Orange	InGaAℓP
TLYE1005B	Yellow	modAti
TLGE1005B	Green	
TLPGE1005B	Pure Green	

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### Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I <sub>F</sub> (mA)	Reverse Voltage V <sub>R</sub> (V)	Power Dissipation P <sub>D</sub> (mW)	Operating Temperature T <sub>opr</sub> (°C)	Storage Temperature T <sub>stq</sub> (°C)
TLRE1005B			60	-40~85	-40~100
TLSE1005B					
TLOE1005B	25	4			
TLYE1005B	23	4			
TLGE1005B					
TLPGE1005B					

### **Electrical Characteristics (Ta = 25°C)**

Product Name	Forward Voltage V <sub>F</sub>				Reverse Current I <sub>R</sub>		
	Min	Тур.	Max	١ <sub>F</sub>	Max	VR	
TLRE1005B	_	1.9	2.4	20	50	4	
TLSE1005B	_	1.9	2.4				
TLOE1005B	_	2.0	2.4				
TLYE1005B	_	2.0	2.4				
TLGE1005B	_	2.0	2.4				
TLPGE1005B	_	2.1	2.4				
Unit	V			mA	μA	V	

### **Optical Characteristics (Ta = 25°C)**

				Emission Spectrum								
Product Name	Luminous Intensity I <sub>V</sub>			Peak emission Wavelength λ <sub>p</sub>		Δλ	Dominant Wavelength $\lambda_d$		١F			
	Min	Тур.	Max	١ <sub>F</sub>	Min	Тур.	Max	Тур.	Min	Тур.	Max	-
TLRE1005B	(153)	450	_		_	(644)	—	(18)	_	630	_	
TLSE1005B	(272)	1000	_		_	(623)	—	(17)	_	613		
TLOE1005B	(476)	1500	_	20	_	(612)	_	(15)	_	605	_	20
TLYE1005B	(272)	850		20	_	(590)	_	(13)		587	_	20
TLGE1005B	(153)	350	_		_	(574)	_	(11)	_	571	_	
TLPGE1005B	(47.6)	130				(562)	_	(11)		558	_	
Unit		mcd		mA		nm		nm		nm		mA

Note: This visible LED lamp also emits some IR light.

If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

TLRE1005B









Radiation pattern





TLSE1005B









Radiation pattern





TLOE1005B









Radiation pattern  $Ta=25^{\circ}C$ 





TLYE1005B









Radiation pattern





TLGE1005B









Radiation pattern





TLPGE1005B









Radiation pattern





### Packaging

The LED devices are packed in an aluminum envelope with silica gel to avoid moisture absorption. The optical characteristics may be affected by exposure to moisture in the air prior to soldering and it should be stored under the following condition is recommended.

Temperature: 5~30°C

Relative Humidity: 60% or lower

Time: 168 h max

Baking is required if the device have been stored unopened for more than 6 months or if the aluminum envelope has been opened for more than 168 h.

Recommended baking condition is 60°C for 12 h minimum in the dry atmosphere.

### **Mounting Method**

### Soldering

• Reflow soldering



- Please perform the first reflow soldering within 168 h after opening the package with reference to the above temperature profile.
- Second time reflow

In case of second reflow soldering, it should be performed within 168 h after first reflow under the above conditions.

Storage conditions before second reflow soldering: 30°C, 60% RH or lower

- Do not perform flow soldering.
- Make any necessary soldering corrections manually.

(Do not do this more than once for any given pin.)

Soldering iron: 25 W

Temperature: no more than 30°C

Time: within 3 s

• Recommended soldering pattern



### **Post Solder Cleaning**

When cleaning after soldering is needed, the following condition must be adhered to.

Cleaning solvents: AK225 or Alcohol

Temperature: 50°C (max) for 30 s (max) or 30°C (max) for 3 minutes (max)

Ultrasonic: 300 W max

### **Precaution for Mounting**

Do not apply force to the plastic part of the LED in high temperature conditions. Do not apply friction using a hard materials for avoid injuring the plastic part of the LED. Keep the LED away from any other parts when assembling boards into the set.

### **Recommended Automatic Surface Mounter Conditions**

Please ask the mounting equipment maker for the ideal automatic mounting conditions.

### **Taping specifications**

This specification lays out the 4 mm pitch embossed-tape packing requirements for 3.2 mm (L)  $\times 2.4 \text{ mm}$  (W)  $\times 2.4 \text{ mm}$  (H) size surface-mount LED lamp.

#### 1. Product naming system

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (this method, however does not apply to products whose electrical characteristics differ from standard Toshiba specifications)

- (1) Tape Type: T03 (4 mm pitch)
- (2) Example



#### 2. Related Matter

(1) Electro-optical Characteristics

Please refer to the each technical datasheet for electro-optical characteristics of tape packed products

(2) Handling Precautions

Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

- (a) In process, taping materials may sustain an electrostatic charge, use an ionizer to neutralize the ions.
- (b) For transport and temporary storage of devices, use containers (boxes, jigs, bags) that are made of anti-static materials or of materials that dissipate electrostatic electricity.

#### 3. Tape Dimensions

Symbol	Dimension	Tolerance
D	1.50	+0.1/-0
E	1.75	±0.1
P <sub>0</sub>	4.00	±0.1
t	0.25	±0.05
F	3.50	±0.05
D <sub>1</sub>	1.10	±0.1

		(Unit in mm)
Symbol	Dimension	Tolerance
P <sub>2</sub>	2.00	±0.05
W	8.00	±0.3
Р	4.00	±0.1
A <sub>0</sub>	2.80	±0.1
B <sub>0</sub>	3.50	±0.1
K <sub>0</sub>	2.70	±0.1



Unit in mm

### 4. Reel Dimensions



### 5. Leader and Trailer



### 6. Packing Form

(1) Number of Devices per Reel and Carton

Reel	1000 devices
Carton	5000 devices

(2) Packing: Silica gel and reel are packed into sealed aluminum pack.

### 7. Notation Method

(1) Example: TLRE1005B (T03)

P	/N:				
	TYPE		TLRE1005B		
	ADD.C		(T03)	QTY	1000 pcs
	NOTE (rank		symbol)		
					Lot Number

(2) Label location:



Aluminum pack: Attached to center of one side